

Pb Free Plating Product

BU508A/BU508D



NPN TYPE TRIPLE DIFFUSED SILICON POWER TRANSISTORS

Features

- ※ Collector-Emitter Sustaining Voltage- $V_{CEX}=1500V$ (min.)
- ※ Stable performances versus operating TEMP variation
- ※ No Damper Diode
- ※ Low base-drive requirement
- ※ High ruggedness

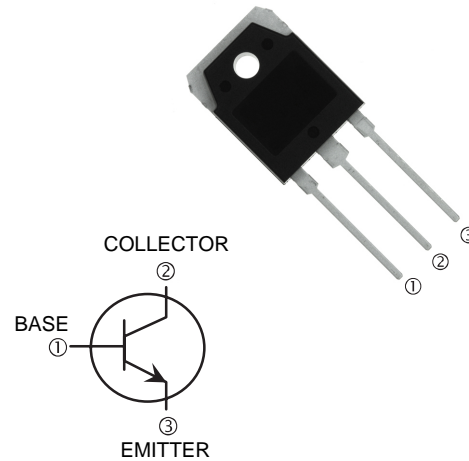
Application

- ※ Large screen colour deflection circuits.
- ※ Ultrasonic equipment system
- ※ Plating Power Supply, Motor Control, UPS and SMPS etc.

Mechanical Data

- ※ Case: TO-3P non-isolated package
- ※ Epoxy: UL 94V-0 rate flame retardant
- ※ Terminals: Solderable per MIL-STD-202 method 208
- ※ Polarity: As per configuration
- ※ Mounting position: Any
- ※ Weight: 6.0 gram approximately

TO-3P pkg outline & internal configuration

**Maximum Ratings**

Characteristic	Symbol	Rating	Unit
Collector-Emitter Voltage	V_{CEO}	700	V
Collector-Emitter Voltage ($V_{BE} = 0$)	V_{CES}	1500	
Emitter-Base Voltage	V_{EBO}	5.0	
Collector Current-Continuous -Peak	I_C	5.0 8.0	A
Base Current-Continuous	I_B	2.5	
Total Power Dissipation at $T_C = 25^\circ C$ Derate above $25^\circ C$	P_D	125 1.0	W W/ $^\circ C$
Operating and Storage Junction Temperature Range	T_J, T_{STG}	-65 to +150	$^\circ C$

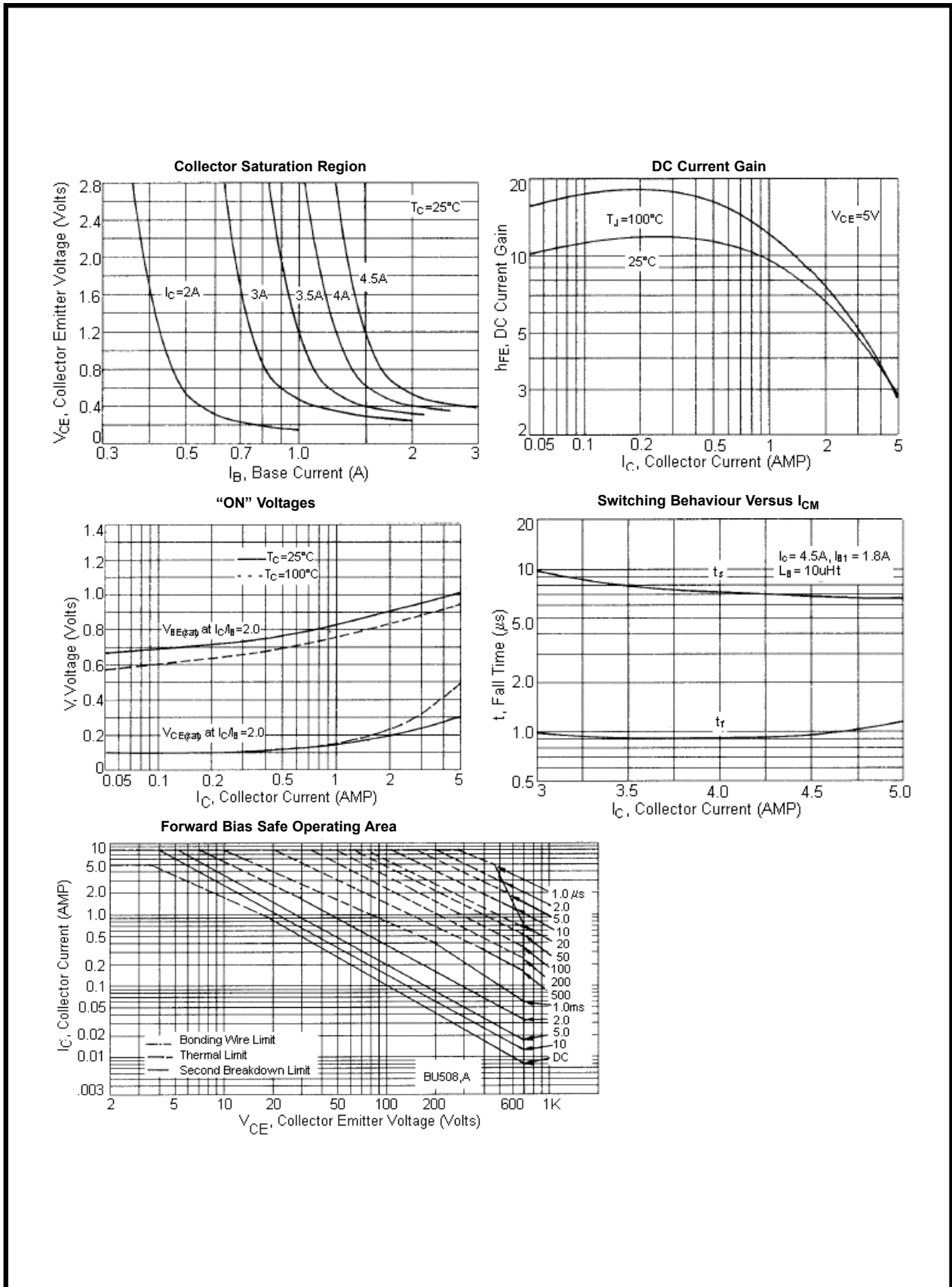
Thermal Characteristics

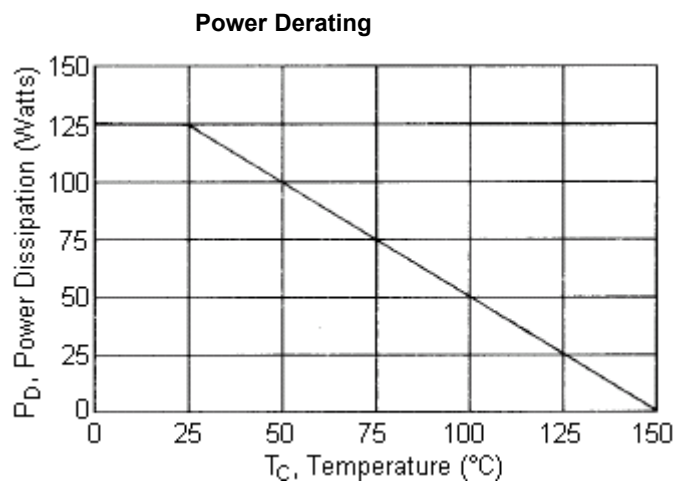
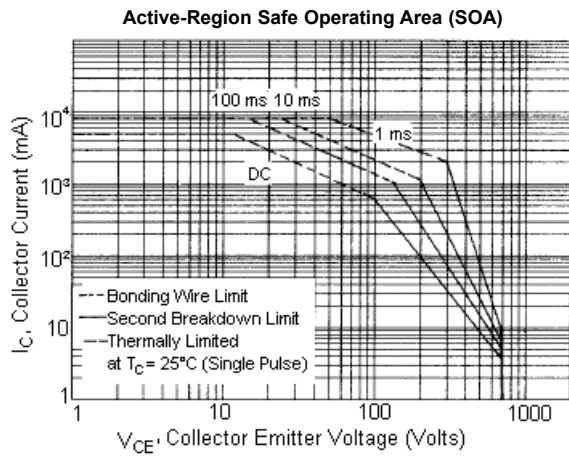
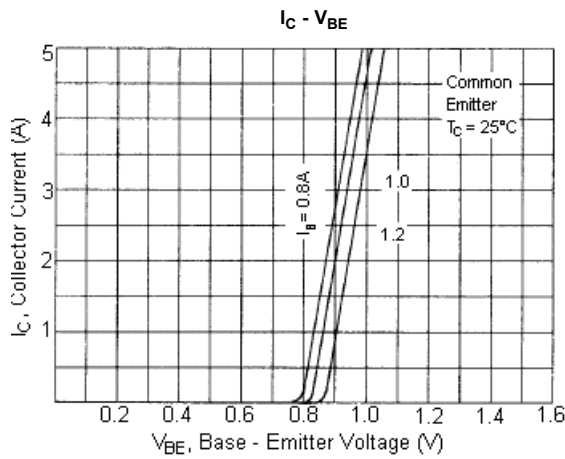
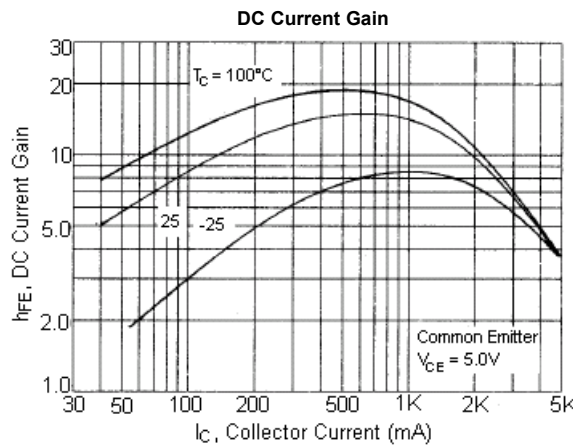
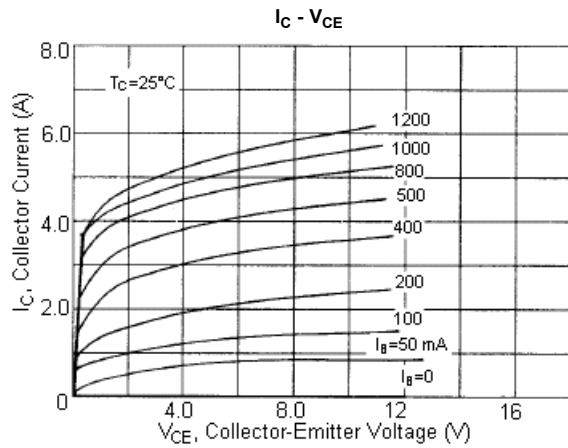
Characteristic	Symbol	Maximum	Unit
Thermal Resistance Junction to Case	$R_{\theta jc}$	1.0	$^\circ C/W$

Electrical Characteristics (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Minimum	Maximum	Unit	
OFF Characteristics					
Collector-Emitter Sustaining Voltage (1) (I _C = 100mA, I _B = 0)	V _{CEO(sus)}	700	-	V	
Collector Cut off Current (V _{CE} = 1500V, V _{BE} = 0)	I _{CES}	-	1.0	mA	
Emitter Cut off Current (V _{EB} = 5.0V, I _C = 0) BU508A BU508D	I _{EBO}	-	10 300		
ON Characteristics (1)					
Collector-Emitter Saturation Voltage (I _C = 4.5A, I _B = 2.0A) BU508A, BU508D	V _{CE(sat)}	-	1.0	V	
Base-Emitter Saturation Voltage (I _C = 4.5A, I _B = 2.0A)	V _{BE(sat)}	-	1.5		
Diode Forward Voltage (I _F = 4.0A) BU508D	V _F	-	2.0		
Dynamic Characteristics					
Current Gain-Bandwidth Product (I _C = 0.1A, V _{CE} = 5.0V, f = 1.0MHz)	f _T	4.0 (Typical)	-	MHz	
Output Capacitance (V _{CE} = 10V, I _E = 0, f = 1.0MHz)	C _{ob}	125 (Typical)	-	pF	
Switching Characteristics					
Storage Time	I _C = 4.5A, I _{B1} = 1.4A, L _B = 10μH	t _s	7.0 (Typical)	-	μs
Fall Time		t _f	1.0 (Typical)	-	

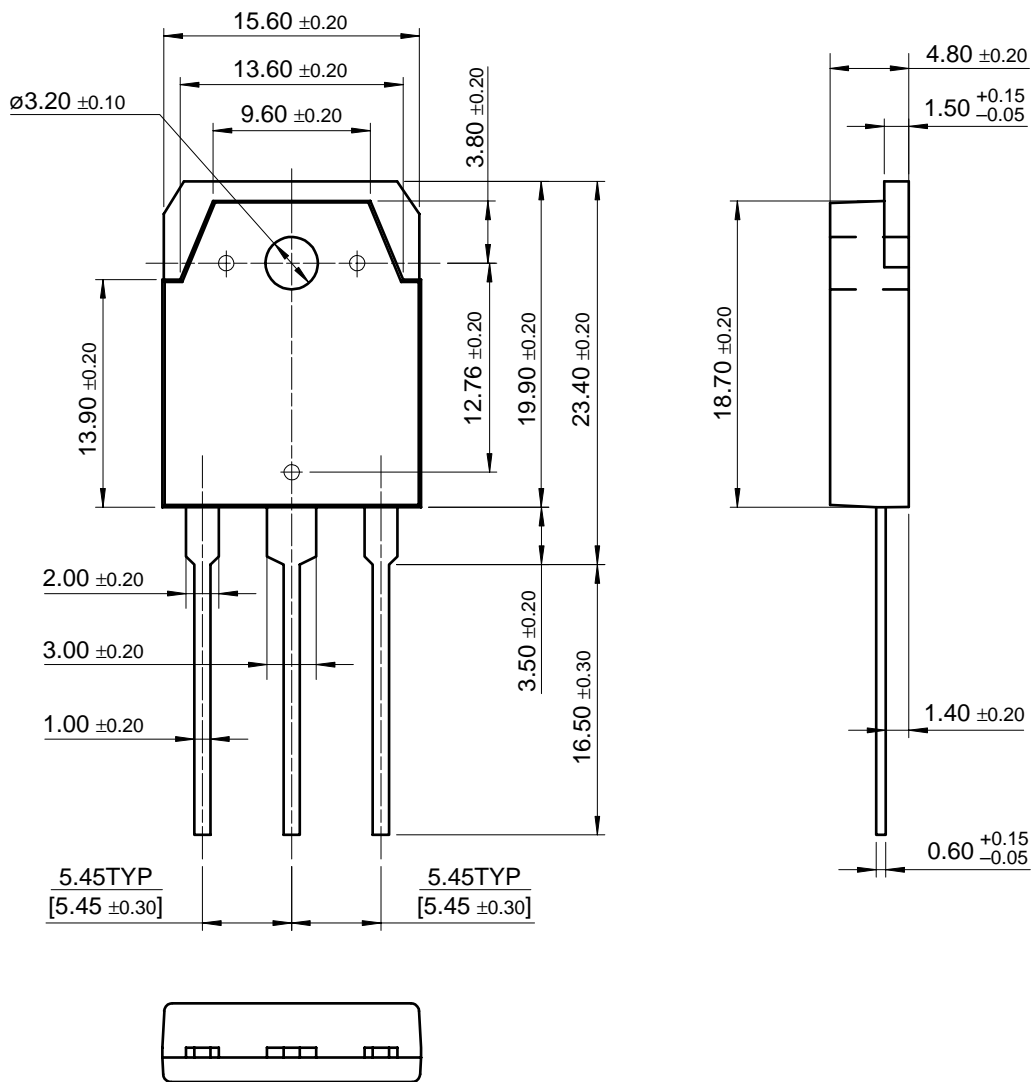
(1) Pulse Test: Pulse Width ≤300μs, Duty Cycle ≤2.0%





THINKI TO-3P Package Dimensions

TO-3P



Dimensions in Millimeters